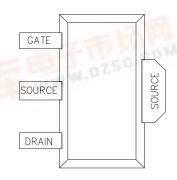


LP750SOT89

LOW NOISE, HIGH LINEARITY PACKAGED PHEMT

FEATURES

- ♦ 26 dBm Output Power at 1-dB Compression at 1.8 GHz
- ♦ 17 dB Power Gain at 1.8 GHz
- 0.7 dB Noise Figure
- ♦ 40 dBm Output IP3 at 1.8 GHz
- ♦ 55% Power-Added Efficiency



DESCRIPTION AND APPLICATIONS

The LP750SOT89 is a packaged Aluminum Gallium Arsenide / Indium Gallium Arsenide (AlGaAs/InGaAs) pseudomorphic High Electron Mobility Transistor (pHEMT). It utilizes a 0.25 µm x 750 µm Schottky barrier gate, defined by electron-beam photolithography. The recessed "mushroom" gate structure minimizes parasitic gate-source and gate resistance. The epitaxial structure and processing have been optimized for reliable high-power applications. The LP750 also features Si3N4 passivation and is available in die form or in other packages.

Typical applications include drivers or output stages in PCS/Cellular amplifiers, WLL and WLAN systems, and other types of wireless infrastructure systems.

ELECTRICAL SPECIFICATIONS @ T_{Ambient} = 25°C

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Saturated Drain-Source Current	I_{DSS}	$V_{DS} = 2 \text{ V}; V_{GS} = 0 \text{ V}$	100	W.07	50	
LP750SOT89-1		68 4B 15	180		230	mA
LP750SOT89-2	1		231		265	mA
Power at 1-dB Compression	P-1dB	$V_{DS} = 5 \text{ V}; I_{DS} = 50\% I_{DSS}$	24	26		dBm
Power Gain at 1-dB Compression	G-1dB	$V_{DS} = 5 \text{ V}; I_{DS} = 50\% I_{DSS}$	15.5	17		dB
Power-Added Efficiency	PAE	$V_{DS} = 5 \text{ V}; I_{DS} = 50\% \text{ I}_{DSS};$ $P_{IN} = 10 \text{ dBm}$		55		%
Noise Figure	NF	$V_{DS} = 5 \text{ V}; I_{DS} = 50\% I_{DSS}$		0.7	17.18	dB
Output Third-Order Intercept Point	IP3	$V_{DS} = 5V; I_{DS} = 50\% I_{DSS};$ $P_{IN} = -7 \text{ dBm}$	电	40	5C.CC	dBm
Maximum Drain-Source Current	I _{MAX}	$V_{DS} = 2 \text{ V}; V_{GS} = 1 \text{ V}$	- WW	450		mA
Transconductance	G_{M}	$V_{DS} = 2 \text{ V}; V_{GS} = 0 \text{ V}$	170	220		mS
Gate-Source Leakage Current	I_{GSO}	$V_{GS} = -5 \text{ V}$		5	45	μΑ
Pinch-Off Voltage	V_{P}	$V_{DS} = 2 \text{ V}; I_{DS} = 4 \text{ mA}$	-0.25	-1.2	-2.0	V
Gate-Source Breakdown Voltage Magnitude	V _{BDGS}	$I_{GS} = 4 \text{ mA}$	-10	-12		V
Gate-Drain Breakdown Voltage Magnitude	$ V_{BDGD} $	$I_{GD} = 4 \text{ mA}$	-10	-13		V

frequency=1.8 GHz



http://www.filss.com Revised: 1/18/02



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Min	Max	Units
Drain-Source Voltage	V _{DS}	$T_{Ambient} = 22 \pm 3 ^{\circ}C$		7	V
Gate-Source Voltage	V_{GS}	$T_{Ambient} = 22 \pm 3 ^{\circ}C$		-3	V
Drain-Source Current	I_{DS}	$T_{Ambient} = 22 \pm 3 ^{\circ}C$		I_{DSS}	mA
Gate Current	I_{G}	$T_{Ambient} = 22 \pm 3 ^{\circ}C$		7.5	mA
RF Input Power	P _{IN}	$T_{Ambient} = 22 \pm 3 ^{\circ}C$		175	mW
Channel Operating Temperature	T_{CH}	$T_{Ambient} = 22 \pm 3 ^{\circ}C$		175	°C
Storage Temperature	T_{STG}	_	-65	175	°C
Total Power Dissipation	P _{TOT}	$T_{Ambient} = 22 \pm 3 ^{\circ}C$		1.75	W

Notes:

Operating conditions that exceed the Absolute Maximum Ratings could result in permanent damage to the device.

• Power Dissipation defined as: $P_{TOT} \equiv (P_{DC} + P_{IN}) - P_{OUT}$, where

P_{DC}: DC Bias Power P_{IN}: RF Input Power P_{OUT}: RF Output Power

Absolute Maximum Power Dissipation to be de-rated as follows above 25°C:

$$\begin{split} P_{TOT} &= 1.75W - (0.012W/^{\circ}C) \text{ x } T_{PACK} \\ where \ T_{PACK} &= \textit{source tab lead temperature} \end{split}$$

This PHEMT is susceptible to damage from Electrostatic Discharge. Proper precautions should be used when handling these
devices.

OPTIMUM POWER OUTPUT MATCHING

	Load State		
Frequency (GHz)	Magnitude	Phase	
1.8	0.39	-168°	
2.2	0.37	-147°	
2.5	0.43	-135°	

HANDLING PRECAUTIONS

To avoid damage to the devices care should be exercised during handling. Proper Electrostatic Discharge (ESD) precautions should be observed at all stages of storage, handling, assembly, and testing. These devices should be treated as Class 1A (0-500 V). Further information on ESD control measures can be found in MIL-STD-1686 and MIL-HDBK-263.

• APPLICATIONS NOTES & DESIGN DATA

Applications Notes are available from your local Filtronic Sales Representative or directly from the factory. Complete design data, including S-parameters, noise data, and large-signal models are available on the Filtronic web site.

LP750SOT89

PACKAGE OUTLINE

(dimensions in inches)

